

High-concentration/high-purity ozone gas generator

# **Pure Ozone Generator**

# Safe continuous supply of High-concentration/high-purity ozone gas



# Pure ozone solution that only our company can realize

High-purity, high-concentration ozone "Pure Ozone" has been refined over many years by Meidensha Co., Ltd. We provide ozone solutions that only we can provide all over the world, such as oxidation source, film formation and reforming.



# **Benefits of Pure Ozone**

High purity : > 80% Ozone Pressure : <10,000Pa	<ul> <li>Achieves over 80% ozone utilization without ozone decomposition at low temperature(*1).</li> <li>⇒Temperature and pressure range that enables the long lifetime of ozone.</li> <li>Pure ozone under reduced pressure is stable and is ideal for vacuum processes.</li> </ul>	
On-demand supply	• <b>On-demand supply of the required amount of pure ozone.</b> Low-concentration ozone generated by conventional ozonizer requires a constant supply of ozone during the vacuum process.	
Compatible with vacuum processes	ALD film formation, surface modification, ashing, and cleaning are possible at low temperature <sup>(*1)</sup> .	
Pure chemical reaction	<ul> <li>Damage-free chemical process without any physical damage as plasma and UV.</li> <li>Ideal for substrates that require low temperatures ("1), such as low heat-resistant semiconductors, resins, and films.</li> </ul>	

### \*1 Low temperature: Room temperature to 150°C

- 100% liquid ozone is extracted.
- by vaporizing only when necessary.





# Utilisation examples



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URE OZONE GENERATOR LINEUP POG lineup for each application				
Intended use	for R&D	for semi-mass production	for mass production	
Number of ozone chambers	1	2	3	
Standard full ozone accumulation volume	16,000cc	32,000cc	48,000cc	
Ozone flow rate	10~300sccm	10~150sccm (1 week to month continuous)	10~150sccm (365 days continuous)	
Unit size	(W)900mm (D)900mm (H)1,700mm	(W)1,100mm (D)1,000mm (H)1,800mm	(W)1,400mm (D)1,000mm (H)1,800mm	
Usage	Oxidation source for MBE			
	Oxidation source for multiple ALDs	Oxidation source for multiple ALDs	Oxidation source for multiple ALDs	
		Oxidation source for surface treatment	Oxidation source for surface treatment	
Unit configuration diagram	Figure 1	Figure2	Figure 3	

### Lineups





We will propose the best configuration per your request

Pure ozone is also available for other applications such as CVD film growth and digital etching (ALE). Please feel free to contact us.



Quality assurance

• A third party tracer gas test has been performed to ensure safety from gas leaks.

### Notification application documents

We can support necessary documentation related to safety measures for installation, please contact individually.

# Application development of pure ozone

-Surface modification in low temperature range -

### Mechanism of Ozone Ethylene Radical (OER) generation

Patented (patent number : 5287558)

High-concentration ozone enables the generation of highly active OH radicals by mixing with ethylene.

By optimizing the pressure ratio of ozone and ethylene, it is possible to maximize the amount of OH radicals generation.



Wafer, glass, resin, etc.

Room temperature OER surface cleaning unit



Uses a shower head structure (Patented)

Uniform OER treatment is possible by spraying pure ozone and ethylene gas onto the base material from the shower head.



### Features

Room temperature reforming is possible Modification at room temperature to 150°C, making the surface hydrophilic.

#### No damage

- Achieves no substrate damage at room temperature, UV and plasma free. Uniform treatment independent of surface shape
- Uniform treatment regardless of surface shape due to high penetration of OH radicals.

#### High efficiency

Maximizing the amount of radical generation on the substrate by process optimization.

Unit specification example			
Usage environment	15~30°C、35~70%RH		
Unit size	1,000mm(W)×900mm(D)×1,800mm(H)		
Base material size	Wafer: 6 inch Substrate (glass, resin): Φ150 or 100mm square		
Process temperature	Room temperature ~150°C		

Demonstration samples of reforming and factory tours are also available. Please feel free to contact us.



### Liquid contact angle



Change over time





#### Liquid contact angle











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ThinkPark Tower, 2-1-1, Osaki, Shinagawa-ku, Tokyo, 141-6029 Japan

www.meidensha.com



## MEIDEN NANOPROCESS INNOVATIONS, INC.

2-8-1, Osaki, Shinagawa-ku, Tokyo, 140-0032, Japan

SALES DEPARTMENT npi-sales@npi.meidensha.co.jp

